



IPW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Thomas Teuschler et al.

Group Art Unit: 2813

Examiner: Tuan H. Nguyen

Serial No.: 10/762,111

Filed: January 21, 2004

For: POLISHED SEMICONDUCTOR WAFER AND PROCESS
FOR PRODUCING IT

Attorney Docket No.: WSAG 0144 PUS

RESPONSE TO ELECTION OF SPECIES REQUIREMENT

Mail Stop Amendment
Commissioner for Patents
U.S. Patent & Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Kindly amend the application as follows:

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8 (FIRST CLASS MAIL)

I hereby certify that this paper, including all enclosures referred to herein, is being deposited with the United States Postal Service as first-class mail, postage pre-paid, in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, U.S. Patent & Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450 on:

1/31/2006

Date of Deposit

William G. Conger
Name of Person Signing

[Signature]
Signature